

# Multilayer Ceramic Chip Capacitors

### C1005X5R1E225K050BE



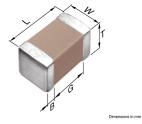






#### **TDK item description** C1005X5R1E225KT\*\*\*S

Applications	Commercial Grade	
Feature	Soft Termination	
Series	C1005 [EIA 0402]	
Status	Production	



	Size
Length(L)	1.00mm +0.25,-0.10mm
Width(W)	0.50mm +0.20,-0.10mm
Thickness(T)	0.50mm +0.20,-0.10mm
Terminal Width(B)	0.10mm Min.
Terminal Spacing(G)	0.30mm Min.
Recommended Land Pattern (PA)	0.30mm to 0.50mm
Recommended Land Pattern (PB)	0.35mm to 0.45mm
Recommended Land Pattern (PC)	0.40mm to 0.60mm

Electrical Characteristics		
Capacitance	2.2µF ±10%	
Rated Voltage	25VDC	
Temperature Characteristic	X5R(±15%)	
Dissipation Factor (Max.)	10%	
Insulation Resistance (Min.)	227ΜΩ	

Other	
Soldering Method	Reflow
AEC-Q200	No
Packing	Punched (Paper)Taping [180mm Reel]
Package Quantity	10000pcs

<sup>!</sup> Images are for reference only and show exemplary products. ! This PDF document was created based on the data listed on the TDK Corporation website.

<sup>!</sup> All specifications are subject to change without notice.

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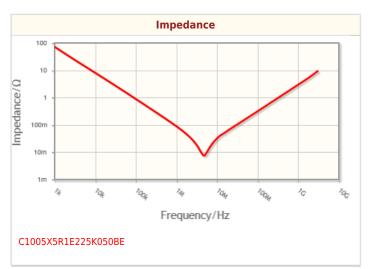


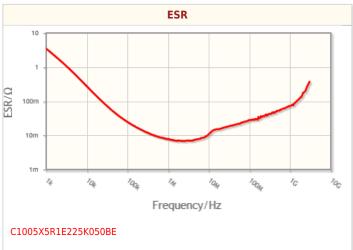


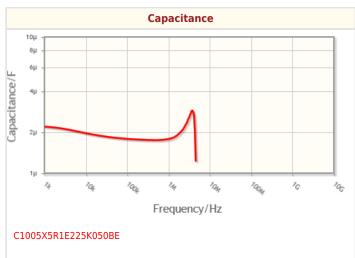


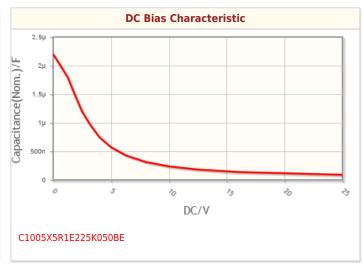


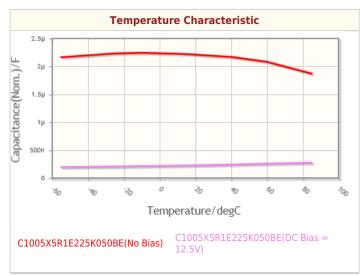
# Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

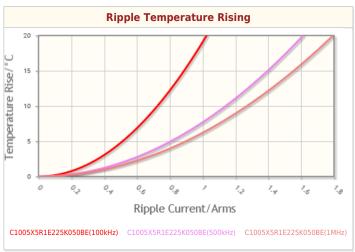












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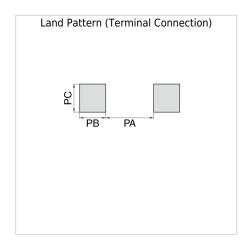








# **Associated Images**



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